

The Effects of Shot Peening Highly Loaded Compression Springs

SAE Fatigue Design & Evaluation
Eden Prairie, MN (May 2018)

Speaker Information

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Participating Companies

Winamac Coil Spring (Kewanna, IN)

Proto Manufacturing (Taylor, MI)

IMR Test Labs (Syracuse, NY)

Introduction

- § Evaluate the effects of fatigue life using various shot peening techniques on a severe duty spring
- § Correlate the fatigue results with residual stress measured via XRD



Spring & Fatigue Test Description

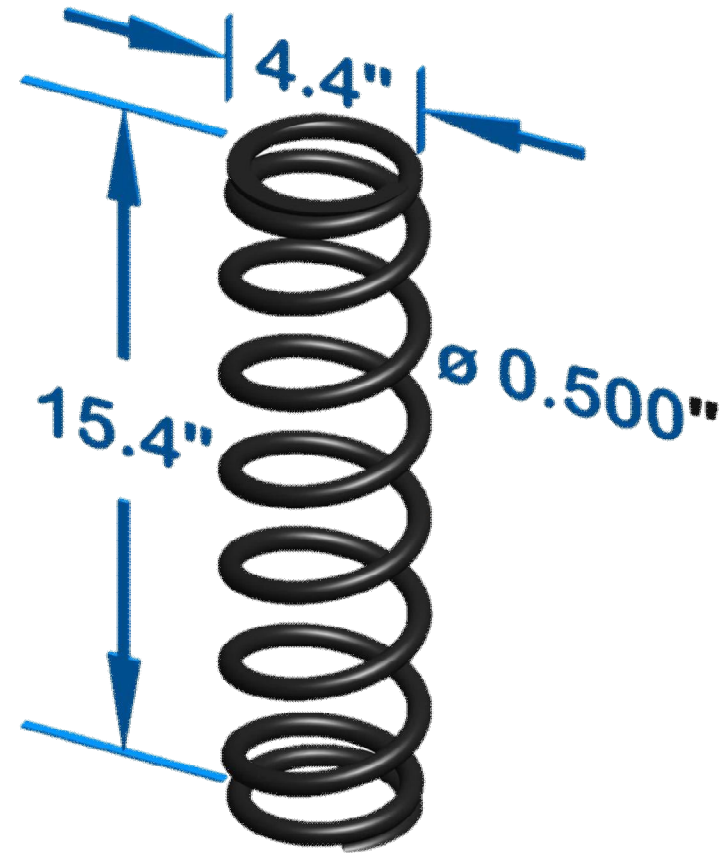
§ ASTM A 401 Cr-Si Wire

– Min TS: 280 ksi

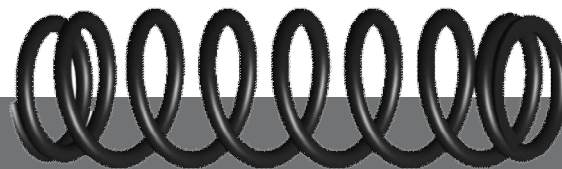
§ Fatigue Test Range:

– 13.7" to 5.25" stroke

- ~ 2" to 10" deflection
- 61.5% of Min TS @ max deflection

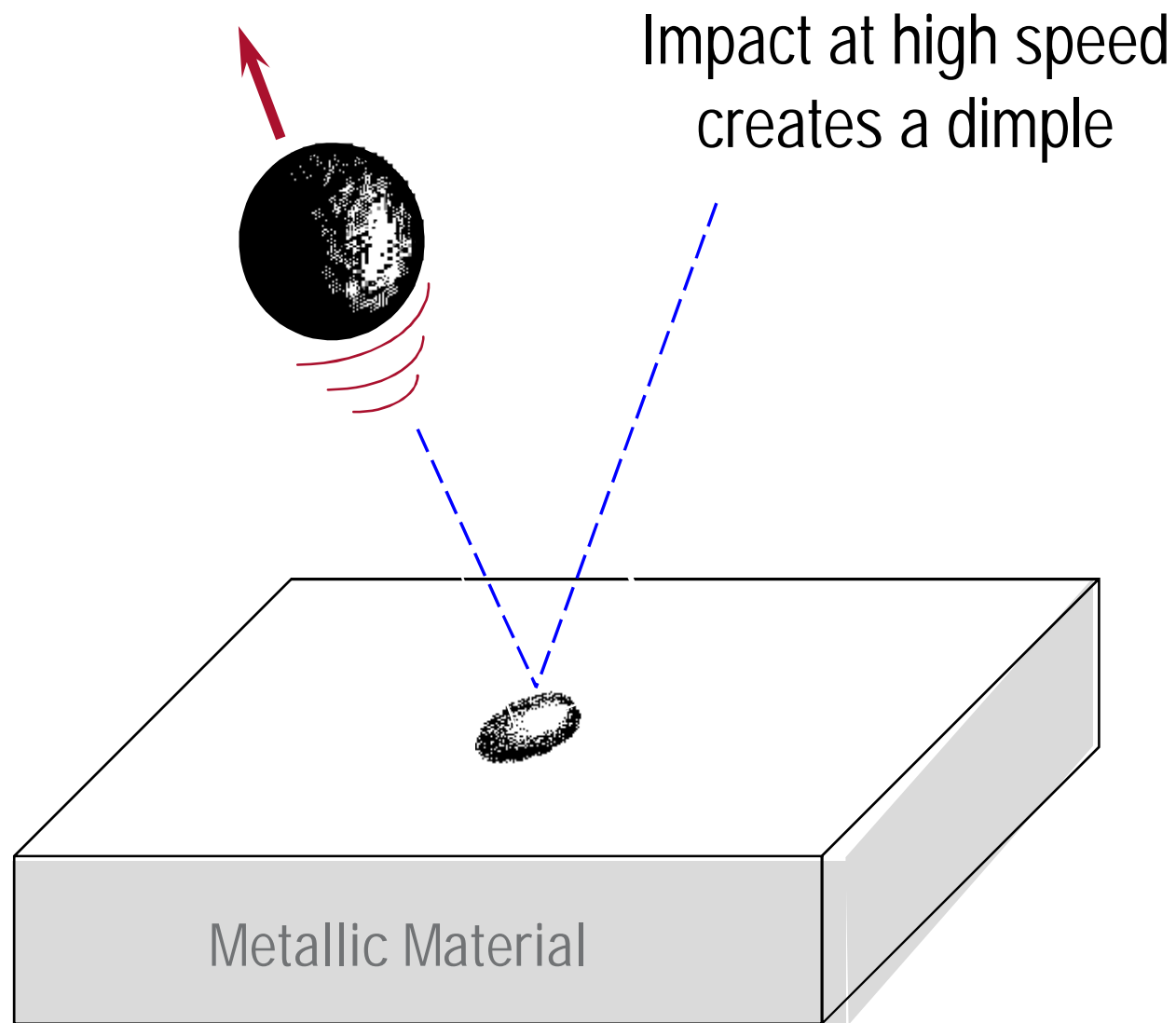


Fatigue Test Setup

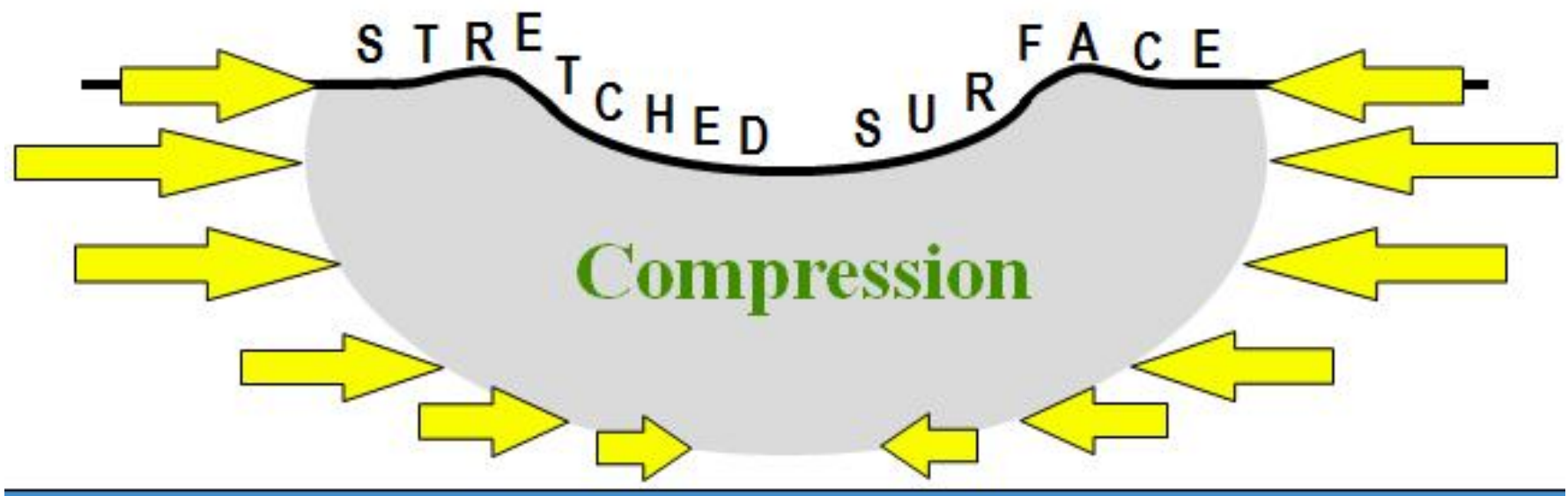


Shot Peening

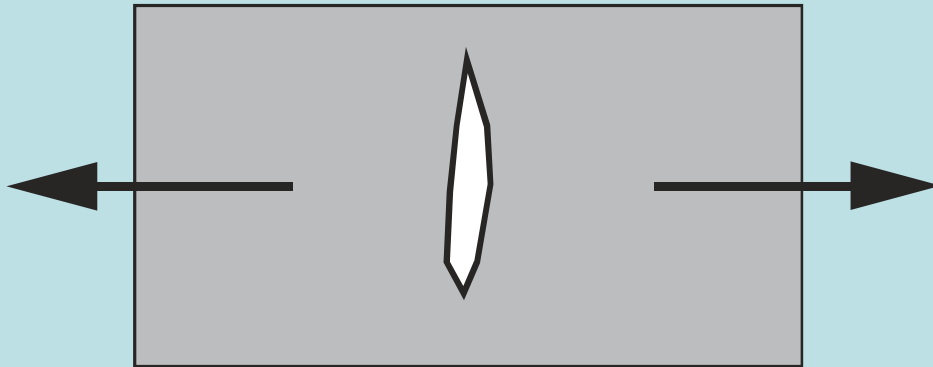
- § Impacts From Small Media Leave Surface in Residual Compression
- § Residual Compressive Stress Lowers Applied Tensile Stress
- § Must Be Carefully Controlled for Repeatable Performance



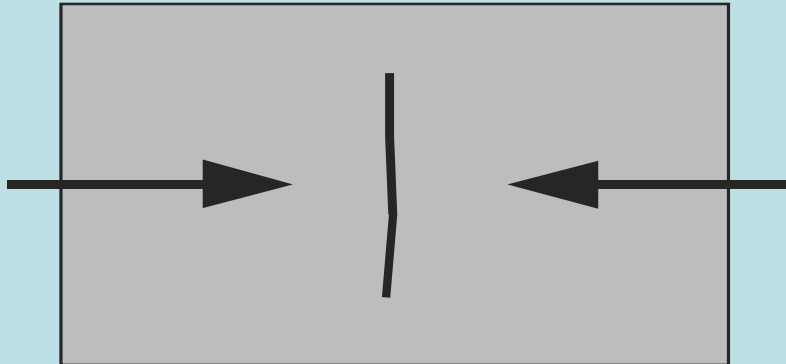
Development of shot peening compressive stress



Residual Stress - Effect on Cracks

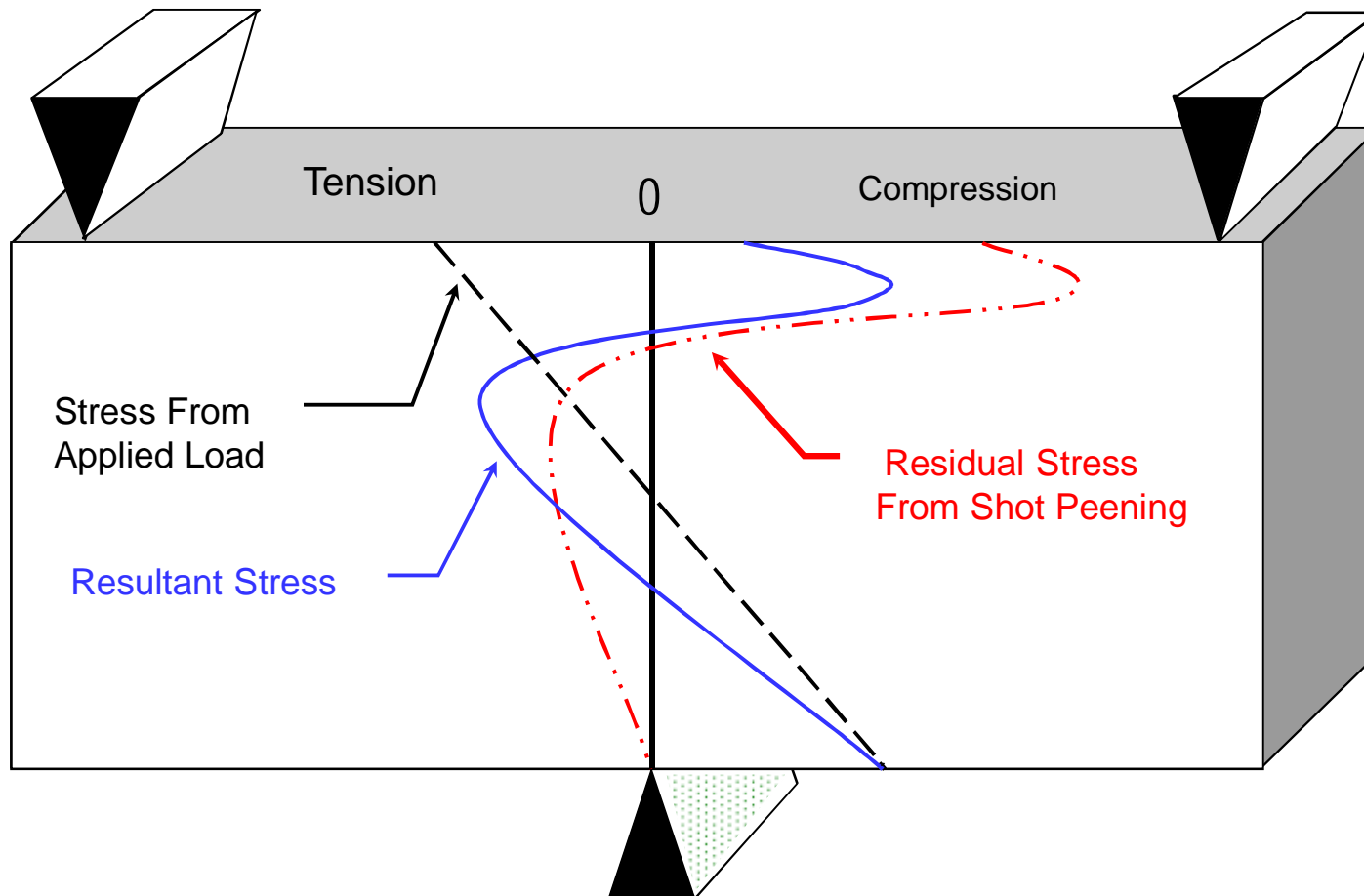


Tensile residual stress
opens crack and increases
crack propagation



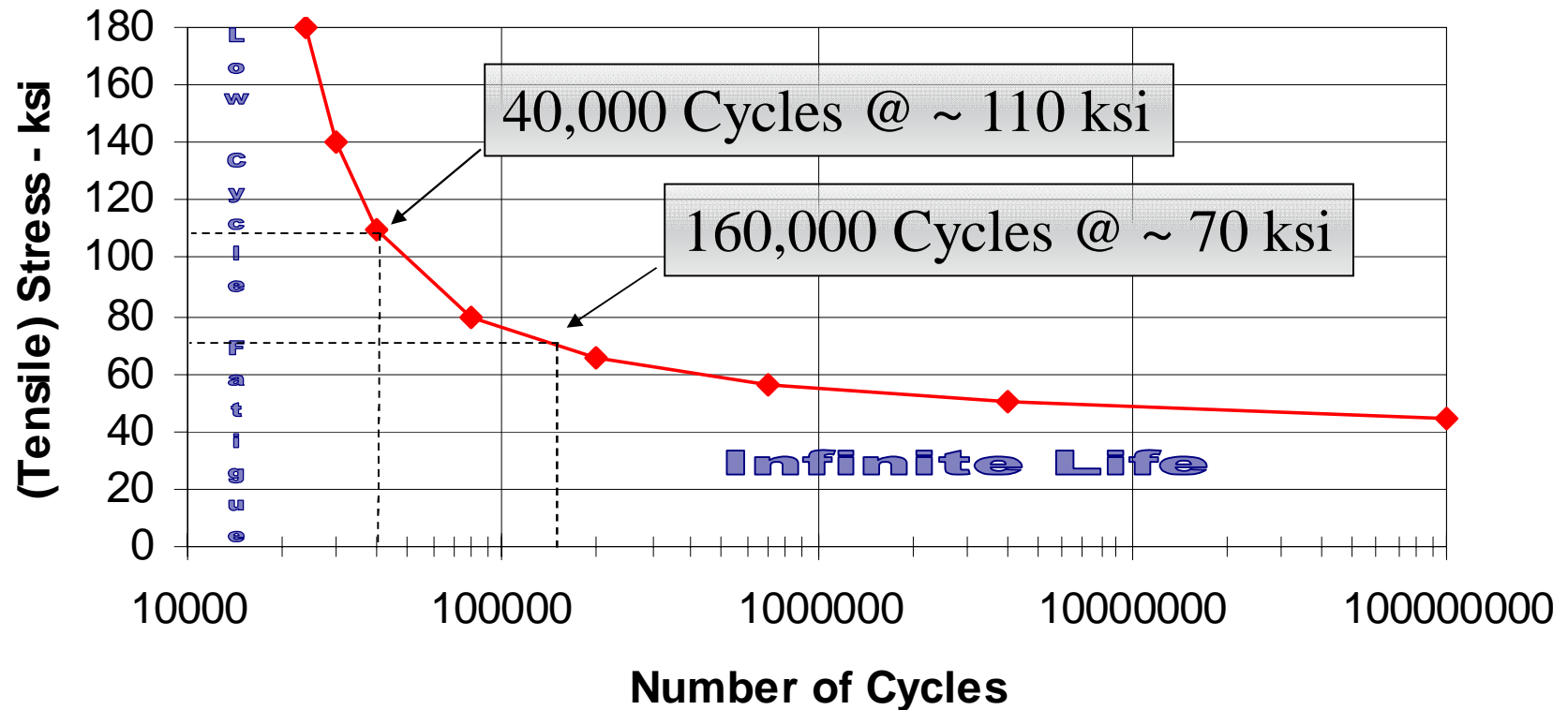
Compressive residual stress
closes crack and slows crack
propagation

Total Stress = Applied + Residual Stress



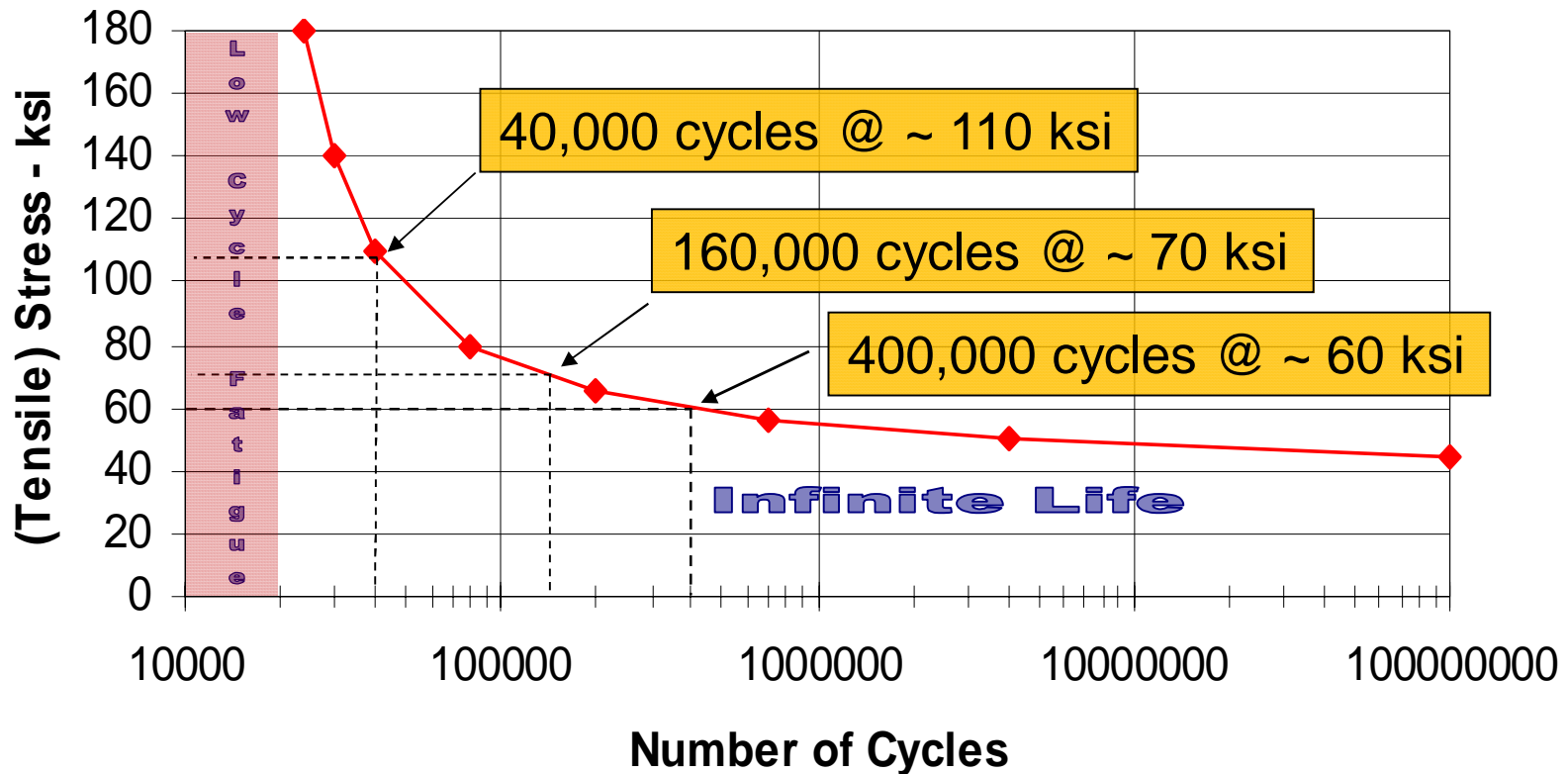
Shot Peening: Linear Decrease in Tensile Stress = Exponential Increase in Fatigue Life

Typical Stress vs Load Cycles



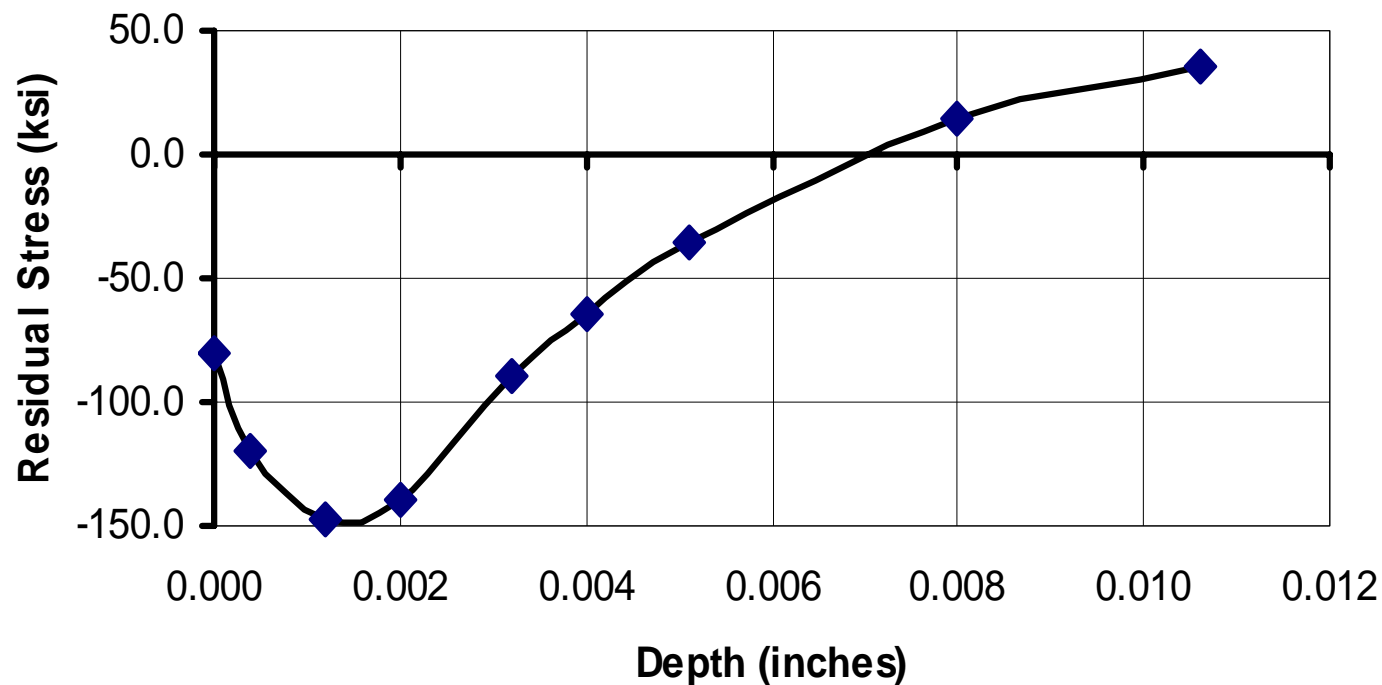
Linear Decrease in Tensile Stress = Exponential Increase in Fatigue Life

Typical Stress vs Load Cycles



Typical Shot Peening Residual Stress Profile

Cr - Si Spring Wire: 260 ksi UTS
MI-230H @ 16 - 20 A



Surface Stress

~ 85 ksi

Max. Compr. Str

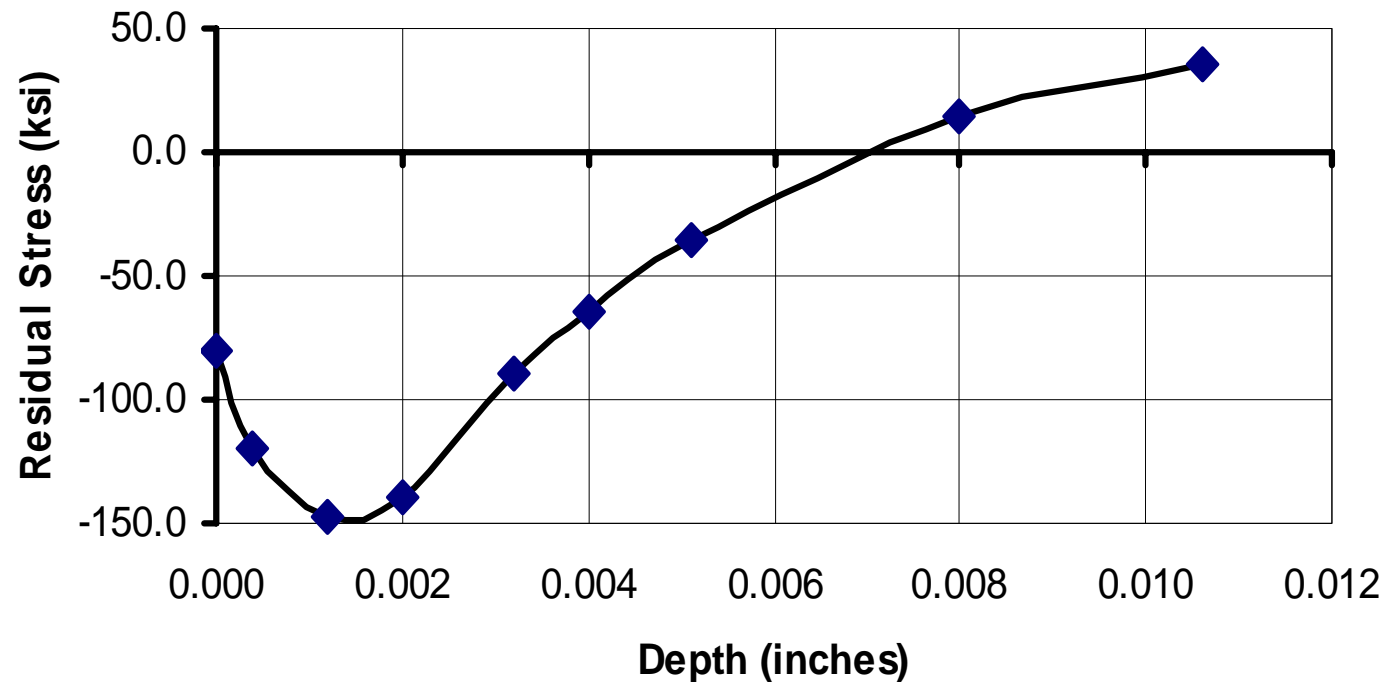
~ 150 ksi

Depth of Compr.

~ .007"

Typical Shot Peening Residual Stress Profile

Cr - Si Spring Wire: 260 ksi UTS
MI-230H @ 16 - 20 A



Surface Stress

~ 85 ksi

Max. Compr. Str

~ 150 ksi

Depth of Compr.

~ .007"

The Surface is Important

- § Applied stress from loading is the highest (torsional stress) at the surface.
- § Residual stress from coiling (tensile) is the highest at the surface.
- § Residual stress from shot peening (compressive) is the highest at the surface.
- § Fatigue cracks start at the material's surface.

Shot Peening Iterations

- § No shot peening vs shot peening
- § Regular hardness shot vs hard shot
- § Lower intensity vs higher intensity
- § Single peening vs dual peening
- § Post shot peening bake vs no post peen bake
- § Order of shot peening & cold pressing

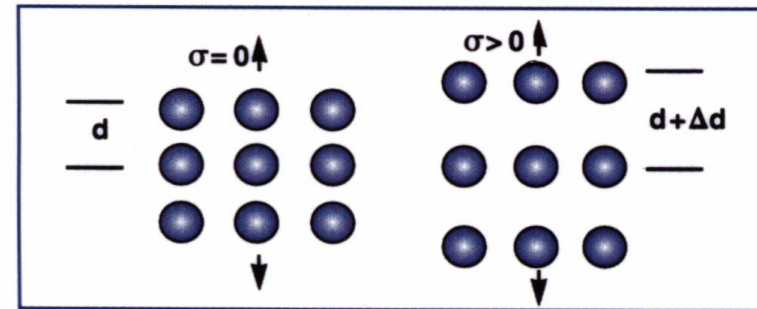
Cold Pressing Was Required

- § Due to very high test stress (172 ksi; 61.5% of UTS), cold pressing was required.
- § Without a cold press, springs would have yielded on first test cycle.
- § This changes the free length and properties of the spring.
- § All springs were cold pressed so proper comparisons could be made.
- § Free Length:
 - ~ 17" before cold press
 - ~ 15.4" after cold press

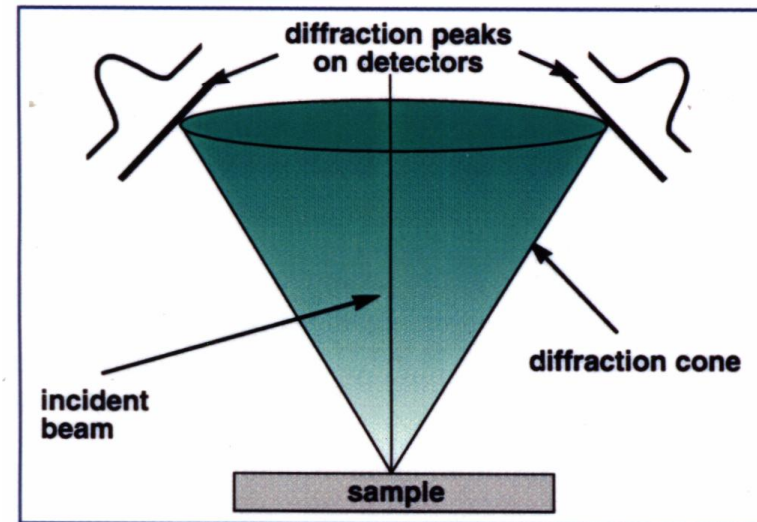
X-Ray Diffraction (XRD)

Measurement of Residual Stress

- An x-ray beam will reflect off of a crystalline material.
- Angle of this reflected beam is directly related to the spacing of atoms in the material as per **Bragg's Law**: $l = 2d \sin q$



Changes in stress cause changes in atomic lattice spacing "d".



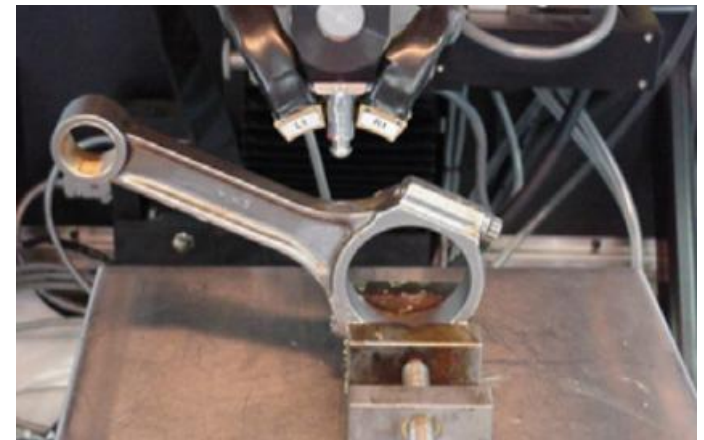
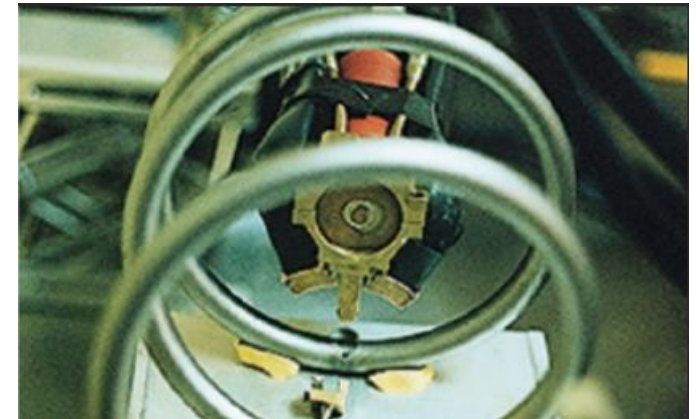
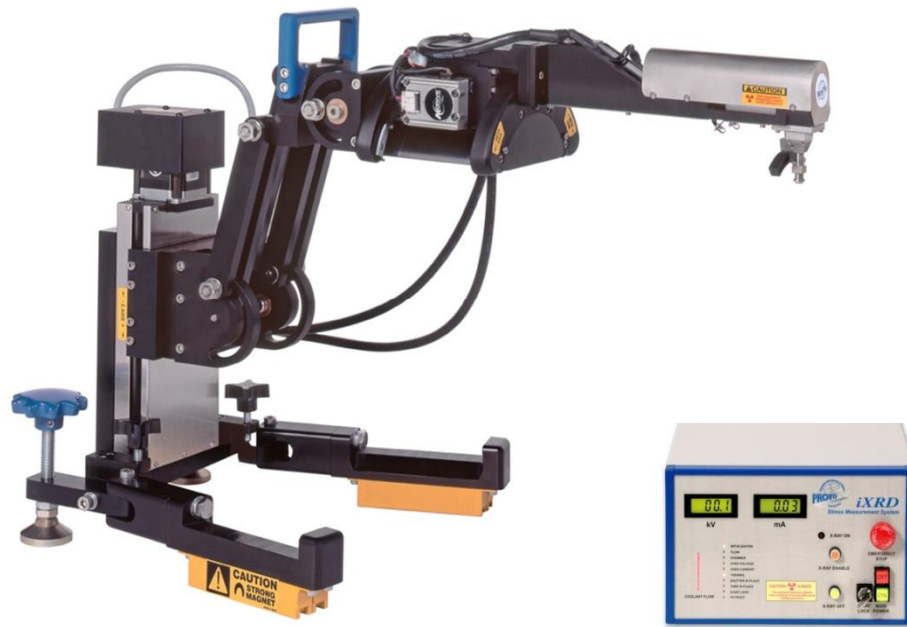
X-Ray Diffraction (XRD)

Measurement of Residual Stress

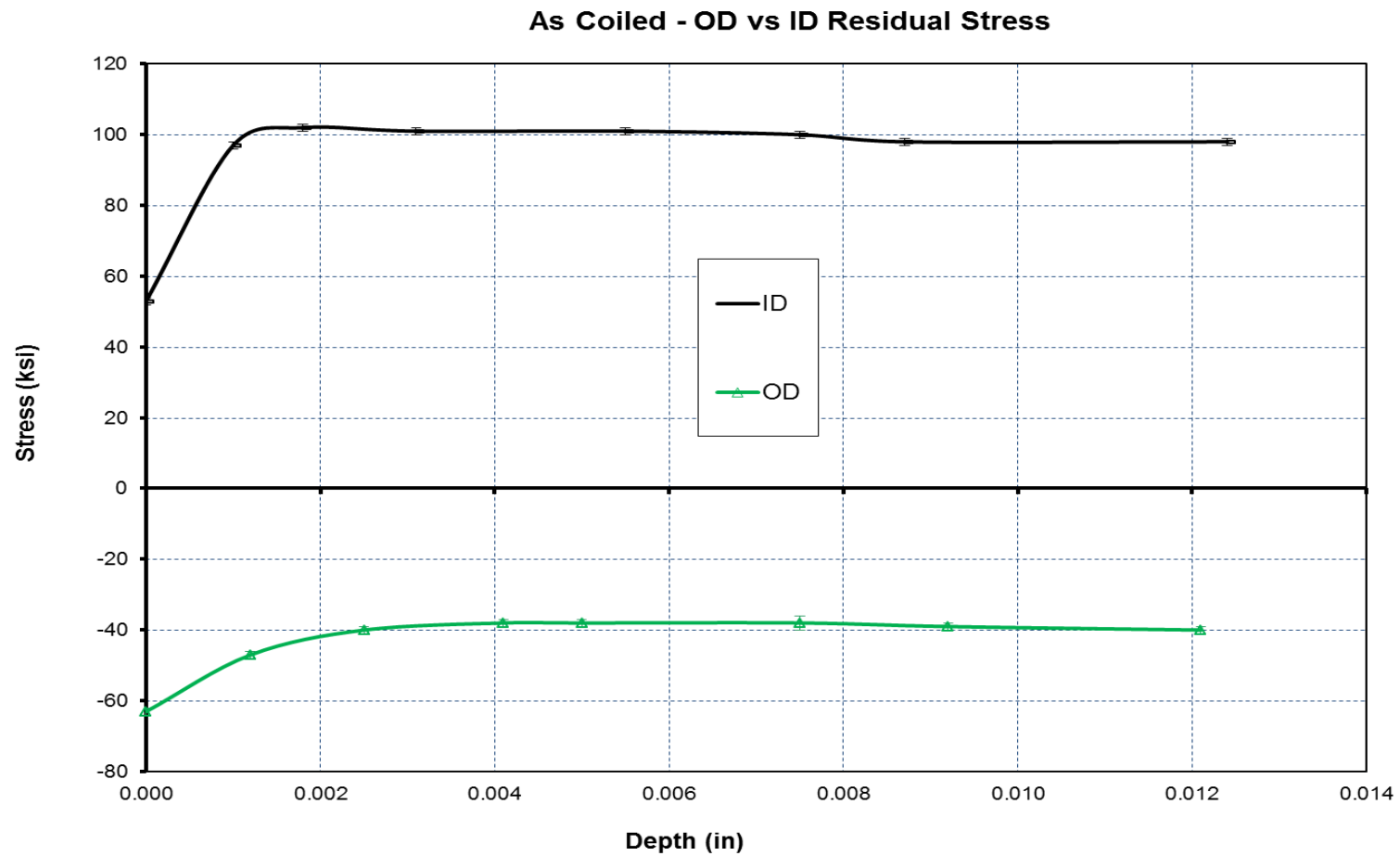
- Measurement of atomic spacing will give the strain of the material.
- Strain is converted to stress via Hook's Law

$$e_{fy} = \frac{1}{2} S_2 s_f \sin^2 y - S_1 (s_{11} + s_{22}) + \frac{1}{2} S_2 t_f \sin 2y$$

X-Ray Diffraction (XRD) Equipment (Fixed & Portable)



Baseline Spring No Peening



Baseline Spring - Observations



20x magnification of
inner diameter

Inner Diameter

~ 60-100 ksi

Residual Tension

* Area of potential failure

Outer Diameter

~ 40-60 ksi

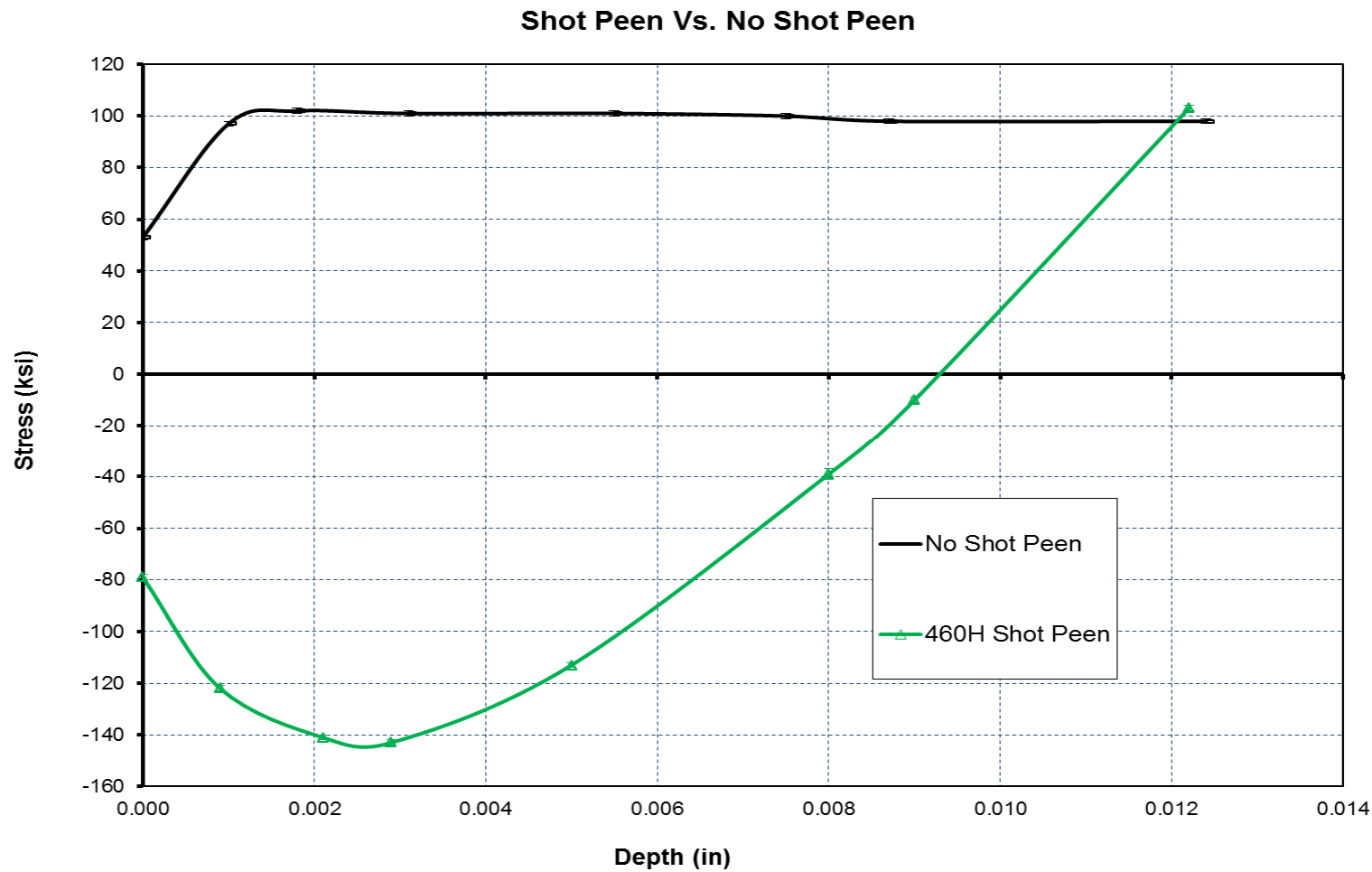
Residual Compression

Residual Stress Differential

ID vs OD

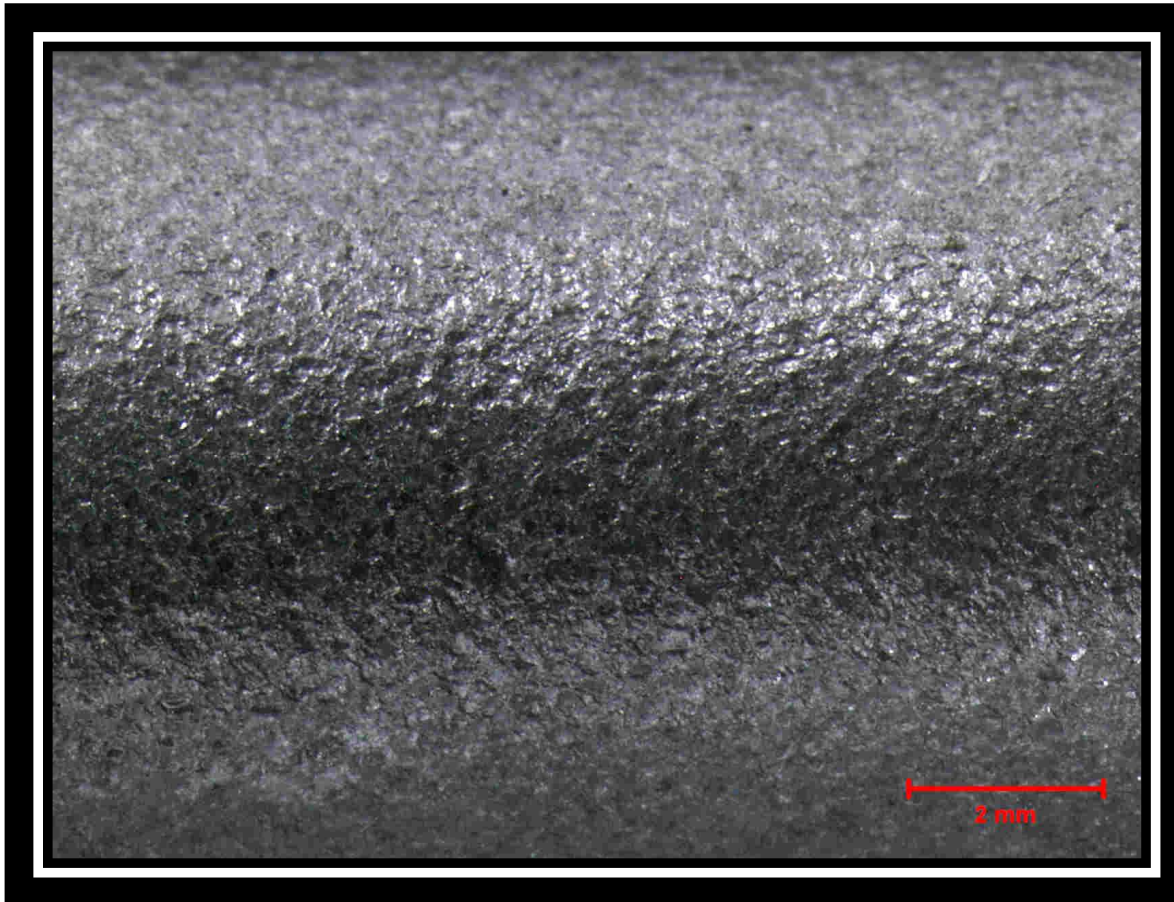
~ 110-140 ksi

460H Shot Peened



Residual Stress at the ID of spring

460H Peened - Observations



20x magnification of
inner diameter

No Shot Peening

11,200 cycles

460H Shot Peening

74,900 cycles

Difference in Resid Stress

Before & After S/P

~ 130-240 ksi

460H Peened – Failure Observations



20x magnification of
inner diameter

82,000 life cycles

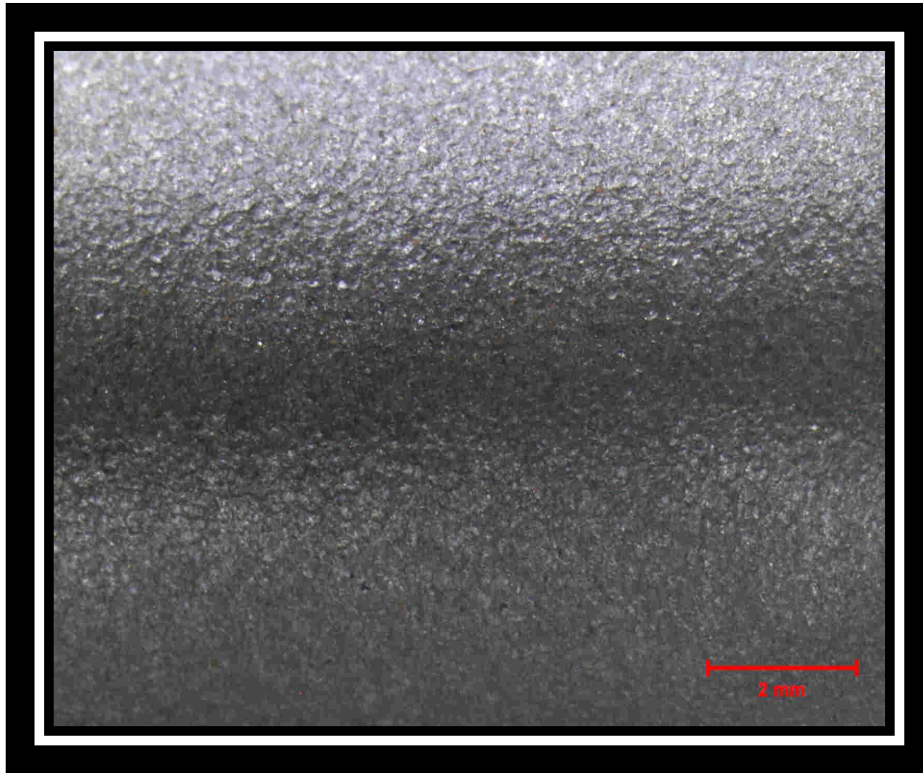
Starts sub-surface

Observable seam.

Fatigue cracks start at
weakest location

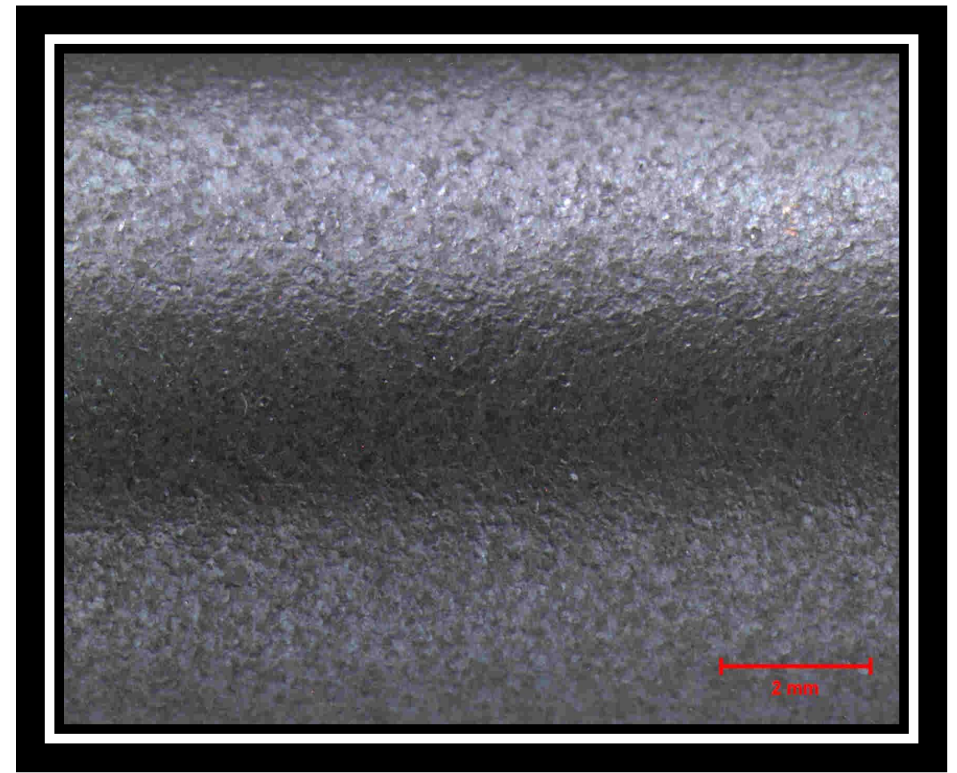
Manufacturing starts with
square bar stock
which is drawn & cold
worked to round

230H & 230R Single Peen



230H

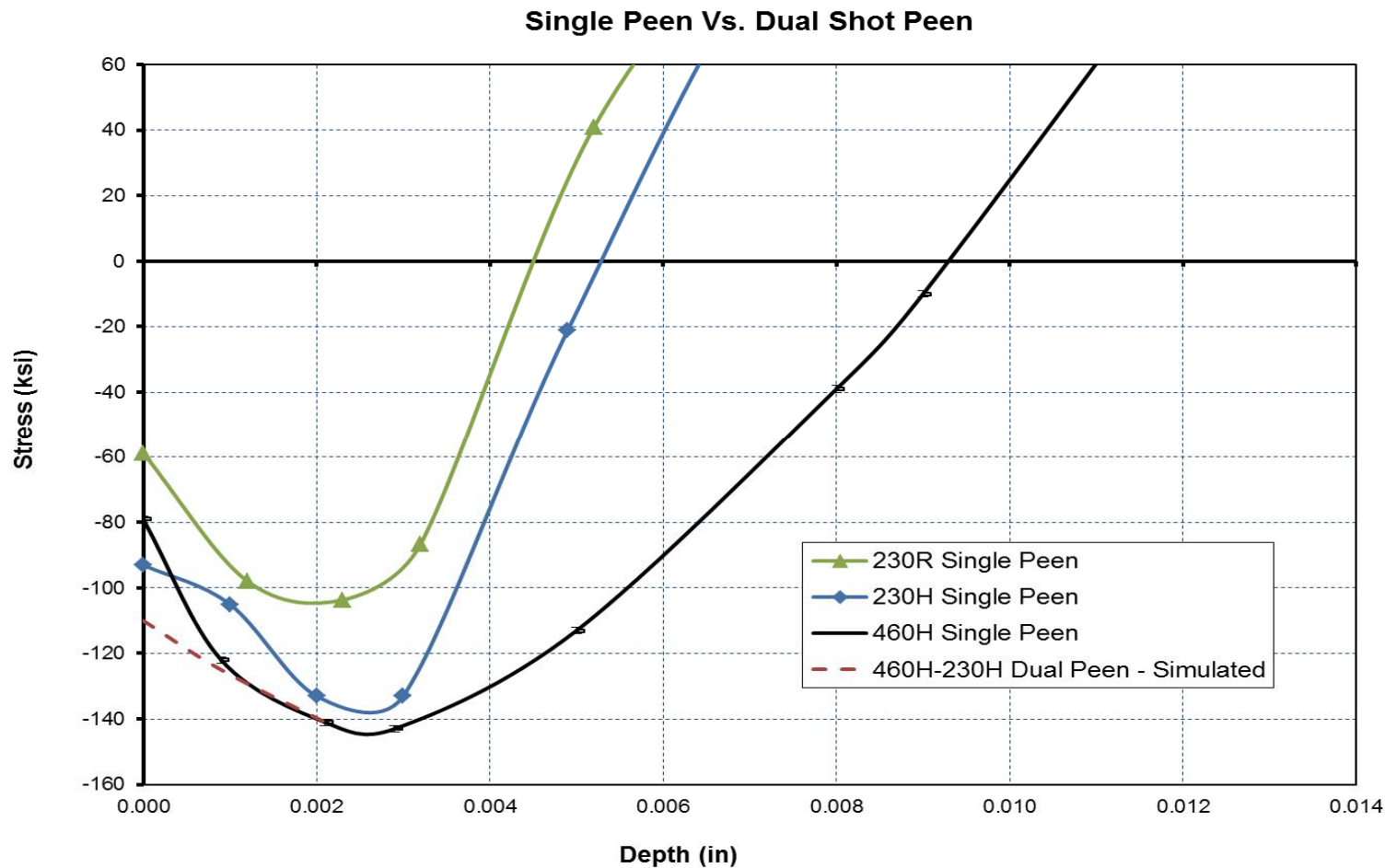
20x magnification of inner
diameter



230R

20x magnification of
inner diameter

Single & Dual Shot Peened



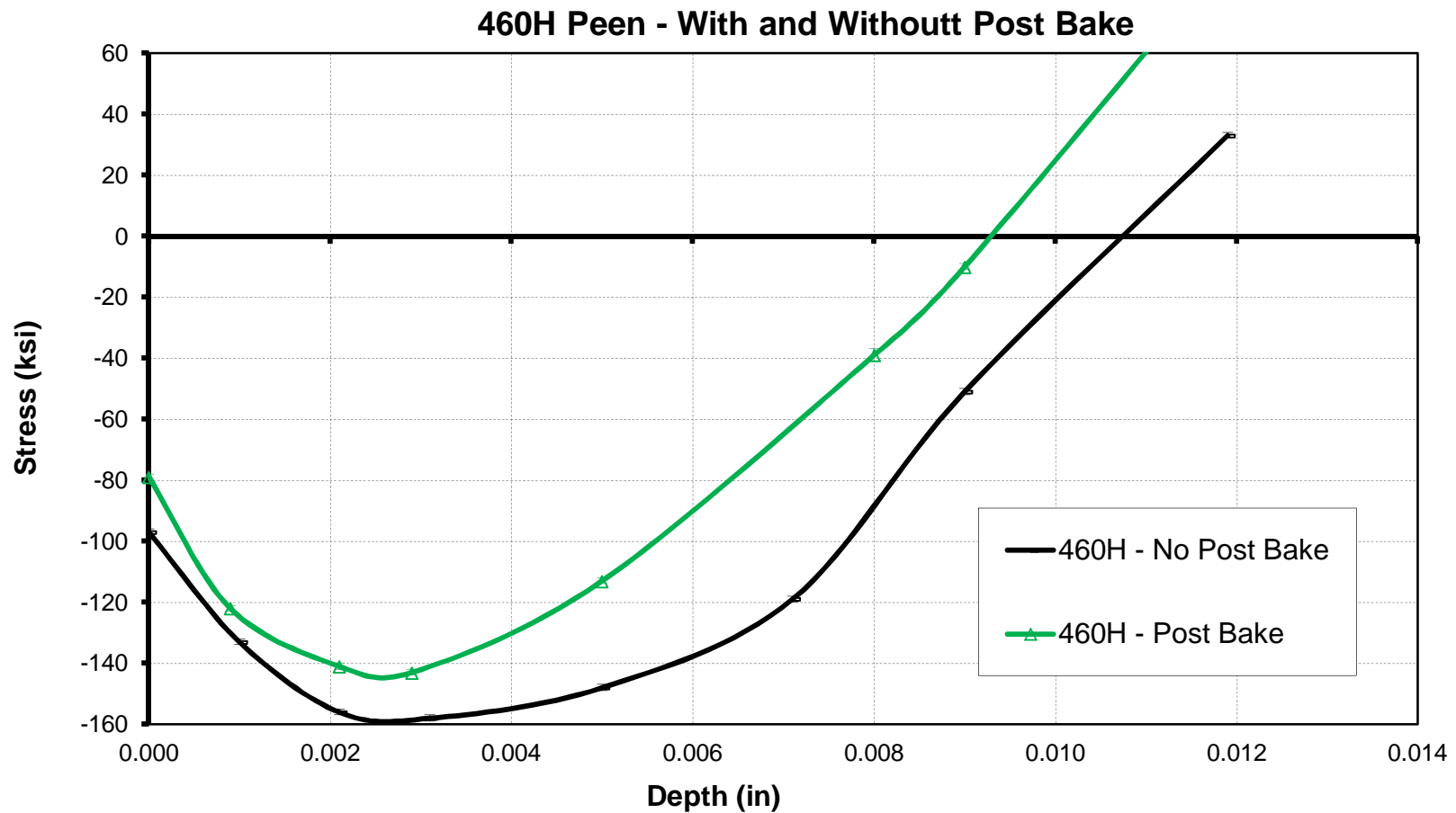
Residual Stress at the ID of spring

Single & Dual Peened Observations

230R @ 0.012-0.016" A	53,200 cycles
230H @ 0.012-0.016" A	62,500
460H @ 0.008-0.010" C	74,900
460H-230H Dual Peen	107,000

- * More residual compressive stress = More fatigue life
(area under the curve)
- * More intensity = More compressive depth
- * 230H & 460H have about same max compressive stress
- * Surface compressive stress & max compressive stress are more important than compressive depth

460H shot peen with & w/out Post Bake



Residual Stress at the ID of spring

460H With & W/Out Post Bake Observations

No Shot Peening	11,200 cycles
460H @ 0.008-0.010" C (with post bake)	81,900
460H @ 0.008-0.010" C (no post bake)	185,900

- **Unexpected Result:** Post baking of shot peened springs is well documented and accepted. The springs without post baking performed (by far) the best in this study.
- * **What we learned:** Post shot peen baking of springs in very highly loaded applications is likely not recommended.
- * **See next slide:** This is a more typical low stress – high cycle fatigue application with benefits of post peen bake

Fatigue Study on Shot Peen Post Bake Temp

No Shot Peen: 335k cycles (100% failure rate)

Shot Peen w/No Bake: 4.4 M (20% failure rate)

S/p w/400 F Bake: 6.0 M (0% failure rate)

S/p w/500 F Bake: 5.4 M (40% failure rate)

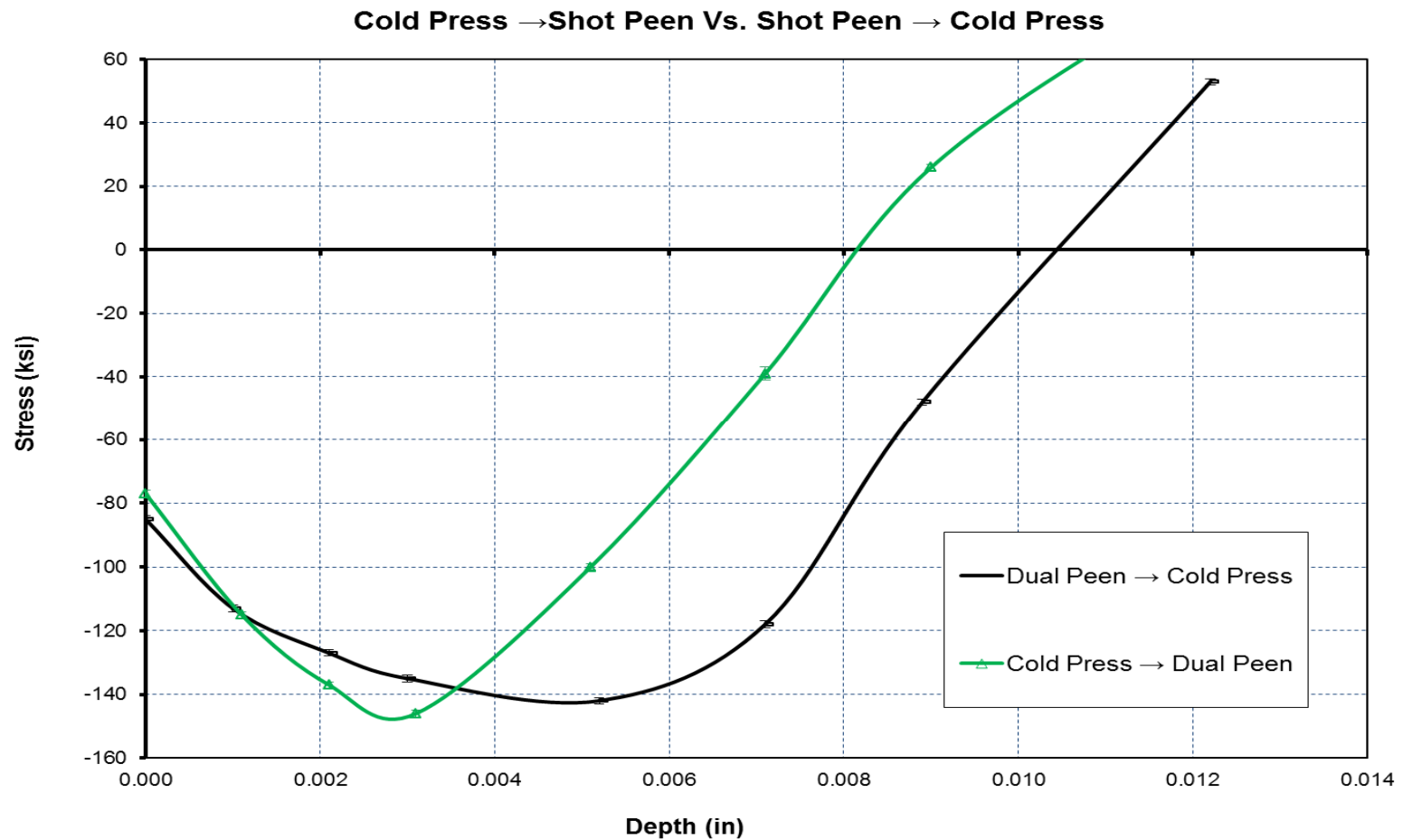
S/p w/600 F Bake: 2.25 M (60% failure rate)

S/p w/700 F Bake: 0.88 M (100% failure rate)

(Note: 0 F thru 500 F tests stopped @ 6 M cycles)

(Note: 600 F thru 700 F tests stopped @ 3 M cycles)

Dual Peen & Cold Press: Reverse Order



Residual Stress at the ID of spring

Cold Press - Dual Peened Reversal Observations

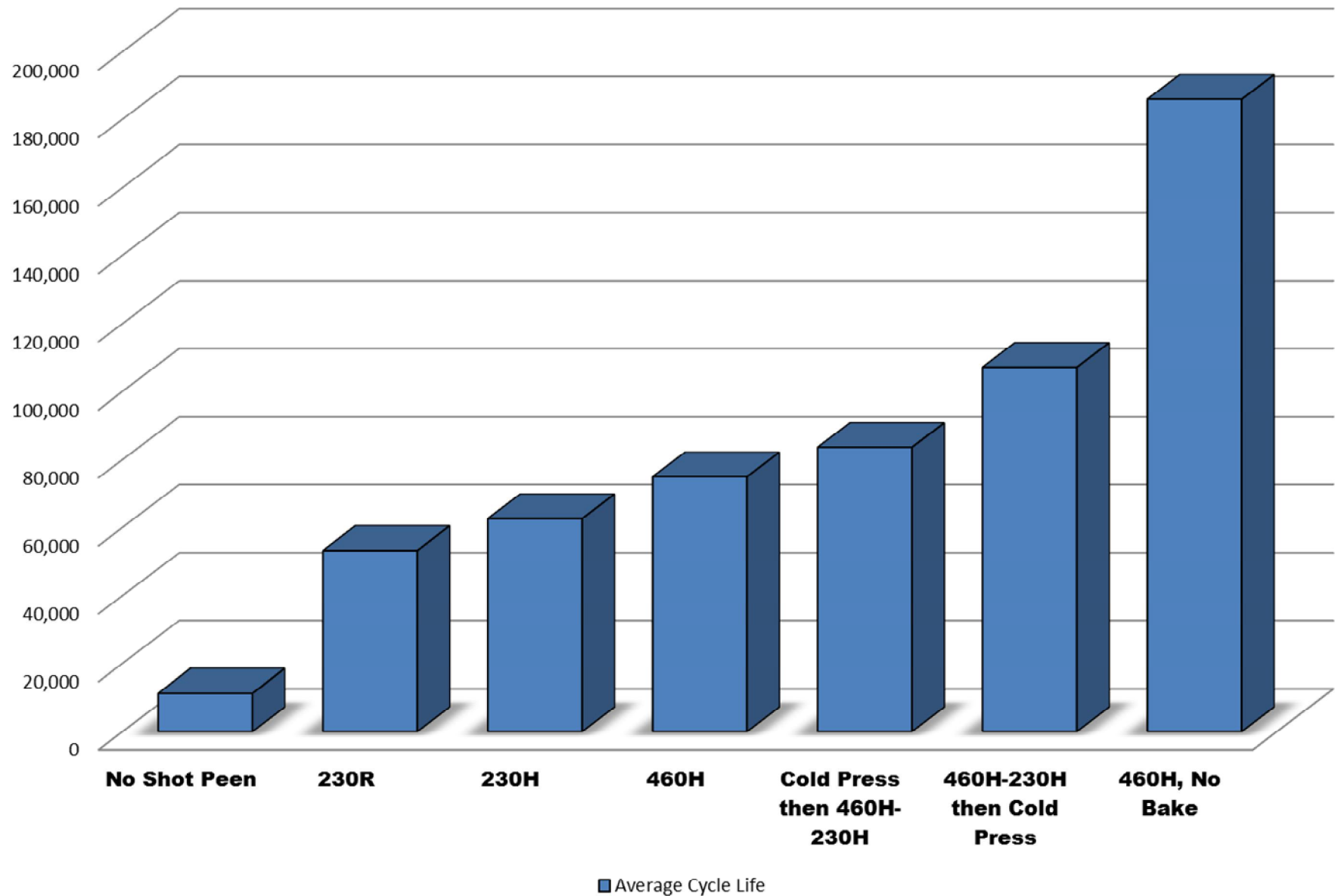
460H-230H Dual Peen then Cold Press	107,000
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460H-230H Cold Press then Dual Peen	83,600
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* Most commonly shot peening happens before cold press. This is better for holding spring tolerance.

* The cold press is able to drive the compressive stress curve deeper.

Fatigue Life Summary: All Iterations



Continuation of Fatigue Study

- § New Spring Designed (smaller Ø wire):
 - Same test stress
 - Reduced load on fatigue test stand
- § Evaluation of additional peening operations
- § Evaluation of post peen temperature on fatigue life
- § Evaluation of alternative media combinations
- § Evaluation of spring 'set' throughout fatigue life

Acknowledgements

Winamac Coil Spring (Kewanna, IN)

Spring Design, Coiling, Fatigue Testing

Proto Manufacturing (Taylor, MI)

X-Ray Diffraction Residual Stress Measurements

Curtiss-Wright: Metal Improvement Company

Shot Peening

IMR Test Labs (Syracuse, NY)

Surface Photography Images